

## C0805X512GATACTU

Aliases (C0805X512GATAC7800) SMD Comm X8G HT150C Flex, Ceramic, 5,100 pF, 2%, 250 VDC, X8G, SMD, MLCC, High Temperature, Ultra-Stable, 0805, 0.6 mm



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General Information	
Series	SMD Comm X8G HT150C Flex
Style	SMD Chip
Description	SMD, MLCC, High Temperature, Ultra-Stable
Features	High Temperature, Ultra-Stable
RoHS	Yes
Termination	Flexible Termination
Marking	No
AEC-Q200	No
Typical Component Weight	13 mg
Shelf Life	78 Weeks
MSL	1

		Specifications	
	0805	Capacitance	5,10
	2mm +/-0.3mm	Measurement Condition	1kH
	1.25mm +/-0.3mm	Tolerance	2%
	0.9mm +/-0.10mm	Voltage DC	250
	0.6mm MIN	Dielectric Withstanding Voltage	625
	0.5mm +/-0.25mm	Temperature Range	-55/
		Temp. Coefficient	X80
ons		Capacitance Change with Reference to +25°C and 0 VDC Applied (TCC)	30 p
	T&R, 180mm, Plastic Tape		

Dimensions Chip Size L W Т s В

## **Packaging Specificatio** Packaging

Packaging Quantity

4000

Specifications	
Capacitance	5,100 pF
Measurement Condition	1 kHz 1.0Vrms
Tolerance	2%
Voltage DC	250 VDC
Dielectric Withstanding Voltage	625 VDC
Temperature Range	-55/+150°C
Temp. Coefficient	X8G
Capacitance Change with Reference to +25°C and 0 VDC Applied (TCC)	30 ppm/C, 1kHz 1.0Vrms
Dissipation Factor	0.1% 1 kHz 1.0Vrms
Aging Rate	0% Loss/Decade Hour: Referee Time is 1000 Hours
Insulation Resistance	100 GOhms

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